

PIC24F16KM204 FAMILY

PIC24F16KM204 Family Silicon Errata and Data Sheet Clarification

The PIC24F16KM204 family devices that you have received conform functionally to the current Device Data Sheet (DS30003030**B**), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in Table 1. The silicon issues are summarized in Table 2.

The errata described in this document will be addressed in future revisions of the PIC24F16KM204 family silicon.

Note:	This document summarizes all silicon									
	errata issues from all revisions of silicon,									
	previous as well as current. Only the issues									
	indicated in the last column of Table 2									
	apply to the current silicon revision (A0).									

Data Sheet clarifications and corrections start on Page 5, following the discussion of silicon issues.

The silicon revision level can be identified using the current version of MPLAB[®] IDE and Microchip's programmers, debuggers, and emulation tools, which are available at the Microchip corporate web site (www.microchip.com). For example, to identify the silicon revision level using MPLAB IDE in conjunction with a hardware debugger:

- 1. Using the appropriate interface, connect the device to the hardware debugger.
- 2. Open an MPLAB IDE project.
- 3. Configure the MPLAB IDE project for the appropriate device and hardware debugger.
- 4. Based on the version of MPLAB IDE you are using, do one of the following:
 - a) For MPLAB IDE 8, select <u>Programmer ></u> <u>Reconnect</u>.
 - b) For MPLAB X IDE, select <u>Window > Dashboard</u> and click the **Refresh Debug Tool** Status icon ().
- 5. Depending on the development tool used, the part number *and* Device Revision ID value appear in the **Output** window.

The DEVREV values for the various PIC24F16KM204 family silicon revisions are shown in Table 1.

Part Number	Device ID ⁽¹⁾	Revision ID for Silicon Revision ⁽²⁾	Part Number	Device ID ⁽¹⁾	Revision ID for Silicon Revision ⁽²⁾
		A0			A0
PIC24FV16KM204	551Fh	-	PIC24F16KM204	551Eh	
PIC24FV08KM204	5517h		PIC24F08KM204	5516h	
PIC24FV16KM104	550Fh		PIC24F16KM104	550Eh	
PIC24FV16KM202	551Bh	00006	PIC24F16KM202	551Ah	0000h
PIC24FV08KM202	5513h	0000h	PIC24F08KM202	5512h	0000h
PIC24FV16KM102	550Bh		PIC24F16KM102	550Ah	
PIC24FV08KM102	5503h		PIC24F08KM102	5502h	
PIC24FV08KM101	5501h		PIC24F08KM101	5500h]

TABLE 1: SILICON DEVREV VALUES

Note 1: The Device IDs (DEVID and DEVREV) are located at the last two implemented addresses of configuration memory space. They are shown in hexadecimal in the format "DEVID DEVREV".

2: Refer to the "PIC24FXXKMXXX/KLXXX Flash Programming Specifications" (DS30625) for detailed information on Device and Revision IDs for your specific device.

Note: If you are unable to extract the silicon revision level, please contact your local Microchip sales office for assistance.

Module	Module Feature Item		Issue Summary	Affected Revisions ⁽¹⁾
		Number		A0
A/D		1.	Excessive current consumption under certain conditions.	Х
A/D	_	2.	Device Reset when sampling upper guardband input.	Х
MCCP and SCCP	Triggered Operation	3.	TRSET bit does not function in retrigger operations.	Х
MCCP and SCCP	Compare Mode	4.	Extra compare event in One-Shot mode under certain conditions.	Х
MCCP and SCCP	Compare Mode	5.	Output compare synchronization does not occur correctly for the first event.	Х
MCCP and SCCP	Compare Mode	6.	Special Event Trigger postscaler does not work.	Х
MCCP and SCCP	_	7.	Unexpected 32-bit timer rollover under certain conditions.	Х
Op Amp	_	8.	Op amp output and digital output drivers may cause bus conflict.	Х
Reset	BOR	9.	Unexpected BOR events when BOR is disabled in Sleep mode.	Х

TABLE 2:SILICON ISSUE SUMMARY

Note 1: Only those issues indicated in the last column apply to the current silicon revision.

Silicon Errata Issues

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated by the shaded column in the following tables apply to the current silicon revision (**A0**).

1. Module: A/D Converter

When low-power operation is enabled (LPEN bit is set), the module may still consume high current (approximately 90 μ A) when the device is in Sleep mode and after the conversion is completed.

Work around

After conversions in Sleep mode are complete, wake the device and disable the module.

Affected Silicon Revisions

A 0				
Х				

2. Module: A/D Converter

Sampling and converting the upper VDD guardband rail input (AD1CHS<12:8> = 11100) may cause a device Reset. This can occur without regard to any other operating conditions.

Work around

Do not use the upper guardband input.

Affected Silicon Revisions

A0				
Х				

3. Module: MCCP and SCCP

In retrigger operation, setting the TRSET bit (CCPxSTATL<6>) may not properly cause a retrigger event. All other available trigger sources will cause a retrigger event as described.

Work around

If the TRSET bit must be used for retrigger operation, set the TRCLR bit (CCPxSTATL<5>) prior to setting the TRSET bit.

Affected Silicon Revisions

A0				
Х				

4. Module: MCCP and SCCP

In One-Shot Output Compare mode, an additional compare event may occur, causing an extra toggling of the OCx pin and an additional interrupt event. This occurs whenever the value of CCPxRA is 0000h, and after the trigger has been cleared and the CCPxTMR is reset.

<u>Work around</u>

A non-zero value of CCPxRA (e.g., 0001h) prevents the additional compare event.

Affected Silicon Revisions

A0				
Х				

5. Module: MCCP and SCCP

Output compare synchronization of the OCx pin to the module's selected time base (enabled when OENSYNC (CCPxCON2H<15>) = 1) may prevent output on the pin on the first time base period after enabling the module. After the first period, OCx pin events will appear correctly.

Work around

None.

Affected Silicon Revisions

	A0				
I	Х				

6. Module: MCCP and SCCP

When the Special Event Trigger output is selected (CCPxCON1H = 1), the interrupt post-scaler setting, selected by CCPxCON1H<11:8>, has no effect. A Special Event Trigger will output on each compare match event.

Work around

None.

Affected Silicon Revisions

A0				
Х				

7. Module: MCCP and SCCP

The MCCP module may rollover at an incorrect time when all of the following conditions are met:

- The module is configured in 32-bit operation (T32 (CCPxCON1L<5>) = 1)
- The CCPxTMRH and CCPxPRH registers are initialized with the same value
- The CCPxTMRL register is initialized with a value higher than CCPxPRL
- The module is configured for a timer match with no external synchronization source (SYNC<4:0> (CCPxCON1H<4:0>) = 00000)

With the module configured this way, the MCCP module will clear the CCPxTMRH/L register pair and generate a timer rollover interrupt when CCPxTMRL rolls over from FFFFh to 0000h, regardless of the value of CCPxTMRH. The expected behavior would be to roll over only after reaching the expected timer rollover value of FFFFFFFFh.

For example, if the module is initialized with the following settings:

- CCPxTMRH = CCPxPRH = 1000h
- CCPxPRL = 0000h
- CCPxTMRL = 0001h

When the module is enabled, it will run until CCPxTMR = 1000FFFFh, then roll over to zero and generate an MCCP timer rollover interrupt.

Work around

None.

Affected Silicon Revisions

A0				
Х				

8. Module: Op Amp

When op amp modules are enabled, a bus conflict between the module's analog driver and the digital I/O driver may result, causing an unexpected voltage level and high-current consumption.

This is only seen when the TRISx bit associated with the OAxOUT pin is cleared. This results in the digital output driver being enabled and conflicting with the op amp's analog output driver.

Work around

When using an op amp module, ensure that the TRISx bit associated with the OAxOUT pin is set as an input (TRISx = 1) to disable the digital output driver.

Affected Silicon Revisions

A0				
Х				

9. Module: Reset

Under certain conditions, the device may improperly perform a Brown-out Reset upon wake-up from a Sleep mode. This has been observed under two conditions:

- When the BOR is disabled in Sleep mode, BOREN<1:0> (FPOR<1:0>) = 10, a BOR may occur when the device wakes from Sleep, regardless of the supply voltage.
- When the BOR is configured for software control (BOREN<1:0> = 01), the device enters and wakes from Sleep normally while the BOR is disabled in software, SBOREN (RCON<13>) = 0. However, if the BOR was disabled prior to entering Sleep mode and is subsequently enabled after waking from Sleep, a BOR may occur regardless of the supply voltage.

BOR functions normally when it is always enabled or disabled (BOREN<1:0> = 11 or 00).

Work around

Do not use Sleep mode when BOREN<1:0> = 10. If the BOR is to operate under software control, always enable the HLVD module, HLVDEN (HLVDCON<15>) = 1, before enabling the BOR in software (SBOREN = 1). This procedure activates the internal band gap reference and assures its stability for the BOR circuit.

Affected Silicon Revisions

A0				
Х				

Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS30003030**B**):

Note: Corrections are shown in **bold**. Where possible, the original bold text formatting has been removed for clarity.

1. Module: Memory Organization

In Table 4-25: A/D Register Map and in Registers 19-6, 19-8 and 19-10, the AD1CHITH, AD1CSSH and AD1CTMENH registers, respectively, it is incorrectly noted that bits 3 and 4 are not implemented on 20-pin devices. These bits are implemented on 20-pin parts, and instead, this note should apply to bits 1 and 2.

2. Module: Electrical Characteristics

Table 27-17: Operational Amplifier Specifications has had the Input Offset Voltage Max value and Common-Mode Input Voltage Range Max value updated, as shown below in **bold**.

TABLE 27-17: OPERATIONAL AMPLIFIER SPECIFICATIONS

DC CHARACTERISTICS			Operating temperature			$\begin{array}{l} 1.8V \mbox{ to } 3.6V \mbox{ (PIC24F16KM204)} \\ 2.0V \mbox{ to } 5.5V \mbox{ (PIC24FV16KM204)} \\ -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ -40^{\circ}C \leq TA \leq +125^{\circ}C \mbox{ for Extended} \end{array}$		
Param No.	Sym	Characteristic	Min	Typ ⁽¹⁾	Max	Units	Comments	
	VIOFF	Input Offset Voltage	_	±2	±50	mV		
	VICM	Common-Mode Input Voltage Range	AVss	—	AVDD - 850	mV		

Note 1: Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.

3. Module: 12-Bit A/D Converter with Threshold Detect

The Note 2 references in Register 19-6: AD1CHITH moved from CHH19 and CHH20 to CHH17 and CHH18. The Table Footnote 2 now reads "The CHH<18:17> bits are not implemented in 20-pin devices."

The Note 2 references in Register 19-8: AD1CSSH moved from CSS19 and CSS20 to CSS17 and CSS18. The Table Footnote 2 now reads "The CSS<18:17> bits are not implemented in 20-pin devices."

The Note 2 reference in Register 19-10: AD1CTMENH moved from CTMEN19 and CTMEN20 to CTMEN17 and CTMEN18. The Table Footnote 2 now reads "The CTMEN<18:17> bits are not implemented in 20-pin devices."

4. Module: Timer1

The first sentence in the Timer1 introduction has changed to the following:

The Timer1 module is a 16-bit timer which operates as a free-running, interval timer/ counter.

5. Module: Capture/Compare/PWM/Timer (MCCP and SCCP)

In Register 13-1: CCPxCON1L, corrections have been made, as shown below in **bold**.

CLKSEL<2:0>: CCPx Time Base Clock Select $\ensuremath{\mathsf{bits}}^{(1)}$

111 = External TCKIA input

- 110 = External TCKIB input
- 101 = CLC1
- 100 = Reserved
- 011 = LPRC (31 kHz source)
- 010 = Secondary Oscillator
- 001 = Reserved
- 000 = System clock (TCY)

6. Module: Special Features

In Register 25-6: FPOR, corrections have been made, as shown below in **bold**.

BORV<1:0>: Brown-out Reset Voltage Level $bits^{(3)}$

7. Module: Master Synchronous Serial Port (MSSP)

In Register 14-3: SSPxCON1, corrections have been made, as shown below in **bold**.

SSPM<3:0>: Master Synchronous Serial Port Mode Select ${\rm bits}^{(3)}$

- 1010 = SPI Master mode,
 - Clock = Fosc/(2 * ([SSPxADD] + 1))
- 0101 = $\frac{\text{SPI}}{\text{SSx}}$ pin control is disabled, $\frac{\text{SCKx}}{\text{SSx}}$ can be used as an I/O pin
- $0100 = \frac{SPI}{SSx}$ Slave mode, Clock = SCKx pin; SSx pin control is enabled
- 0011 = Reserved
- 0010 = SPI Master mode, Clock = Fosc/32
- 0001 = SPI Master mode, Clock = Fosc/8
- 0000 = SPI Master mode, Clock = Fosc/2

8. Module: Real-Time Clock and Calendar (RTCC)

The FRM referenced for the RTCC module in Section 16.0 "Real-Time Clock and Calendar (RTCC)" has been corrected. The note with the correct reference is shown below in **bold**.

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on the Real-Time Clock and Calendar, refer to the "PIC24F Family Reference Manual", "RTCC with External Power Control" (DS39745).

9. Module: Configurable Logic Cell

In Register 17-4: CLCxGLSL, the following corrections have been made, as shown below in **bold**.

bit 15	G2D4T: Gate 2 Data Source 4 True Enable bit
	1 = The Data Source 4 signal is enabled for Gate 2
	0 = The Data Source 4 signal is disabled for Gate 2
bit 14	G2D4N: Gate 2 Data Source 4 Negated Enable bit
	1 = The Data Source 4 inverted signal is enabled for Gate 2
	0 = The Data Source 4 inverted signal is disabled for Gate 2
bit 13	G2D3T: Gate 2 Data Source 3 True Enable bit
	1 = The Data Source 3 signal is enabled for Gate 2
	0 = The Data Source 3 signal is disabled for Gate 2
bit 12	G2D3N: Gate 2 Data Source 3 Negated Enable bit
	1 = The Data Source 3 inverted signal is enabled for Gate 2
	0 = The Data Source 3 inverted signal is disabled for Gate 2
bit 11	G2D2T: Gate 2 Data Source 2 True Enable bit
	1 = The Data Source 2 signal is enabled for Gate 2
	0 = The Data Source 2 signal is disabled for Gate 2
bit 10	G2D2N: Gate 2 Data Source 2 Negated Enable bit
	1 = The Data Source 2 inverted signal is enabled for Gate 2
	0 = The Data Source 2 inverted signal is disabled for Gate 2
bit 9	G2D1T: Gate 2 Data Source 1 True Enable bit
	1 = The Data Source 1 signal is enabled for Gate 2
	0 = The Data Source 1 signal is disabled for Gate 2
bit 8	G2D1N: Gate 2 Data Source 1 Negated Enable bit
	1 = The Data Source 2 inverted signal is enabled for Gate 1
	0 = The Data Source 2 inverted signal is disabled for Gate 1
bit 7	G1D4T: Gate 1 Data Source 4 True Enable bit
	1 = The Data Source 4 signal is enabled for Gate 1
	0 = The Data Source 4 signal is disabled for Gate 1
bit 6	G1D4N: Gate 1 Data Source 4 Negated Enable bit
	1 = The Data Source 4 inverted signal is enabled for Gate 1
	0 = The Data Source 4 inverted signal is disabled for Gate 1
bit 5	G1D3T: Gate 1 Data Source 3 True Enable bit
	 1 = The Data Source 3 signal is enabled for Gate 1 0 = The Data Source 3 signal is disabled for Gate 1
bit 4	-
DIL 4	G1D3N: Gate 1 Data Source 3 Negated Enable bit 1 = The Data Source 3 inverted signal is enabled for Gate 1
	0 = The Data Source 3 inverted signal is chabled for Gate 1
bit 3	G1D2T: Gate 1 Data Source 2 True Enable bit
bit 5	1 = The Data Source 2 signal is enabled for Gate 1
	0 = The Data Source 2 signal is disabled for Gate 1
bit 2	G1D2N: Gate 1 Data Source 2 Negated Enable bit
	1 = The Data Source 2 inverted signal is enabled for Gate 1
	0 = The Data Source 2 inverted signal is disabled for Gate 1
bit 1	G1D1T: Gate 1 Data Source 1 True Enable bit
	1 = The Data Source 1 signal is enabled for Gate 1
	0 = The Data Source 1 signal is disabled for Gate 1
bit 0	G1D1N: Gate 1 Data Source 1 Negated Enable bit
	1 = The Data Source 1 inverted signal is enabled for Gate 1
	0 = The Data Source 1 inverted signal is disabled for Gate 1

PIC24F16KM204 FAMILY

10. Module: Electrical Characteristics

in Table 27-22: Internal RC Oscillator Accuracy, the following note has been added for the LRPC:

3: In High-Power/High-Accuracy mode, the Configuration bit, LPRCSEL = 1.

11. Module: Capture/Compare/PWM/Timer (MCCP and SCCP)

In Section 13.2 "General Purpose Timer", the text has been updated to omit the sentence below:

The secondary timer uses CCPxTMRH and CCPxPRH. It is intended to be used only as a periodic interrupt source for scheduling CPU events. It does not generate an Output Sync/Trigger signal like the primary time base.

In Dual Timer mode, the Secondary Timer Period register, CCPxPRH, generates the MCCP Compare Event.

12. Module: Capture/Compare/PWM/Timer (MCCP and SCCP)

The following changes have been made to Register 19-1: AD1CON1, as shown below in **bold**.

SSRC<3:0>: Sample Clock Source Select bits 1111 = Reserved

- •
- •
- 1101 = Reserved
- 1100 = CLC2 event ends sampling and starts conversion
- 1011 = SCCP4 Capture/Compare Event or Timer (CCP4IF/CCT4IF) ends sampling and starts conversion
- 1010 = MCCP3 Capture/Compare Event or Timer (CCP3IF/CCT3IF) ends sampling and starts conversion
- 1001 = MCCP2 Capture/Compare Event or Timer (CCP2IF/CCT2IF) ends sampling and starts conversion
- $\verb"looo"$ = CLC1 event ends sampling and starts conversion
- 0111 = Internal counter ends sampling and starts conversion (auto-convert)
- 0110 = TMR1 Sleep mode Trigger event ends sampling and starts conversion⁽¹⁾
- Olol = TMR1 event ends sampling and starts conversion
- 0100 = CTMU event ends sampling and starts conversion
- 0011 = SCCP5 Capture/Compare Event or Timer (CCP5IF/CCT5IF) ends sampling and starts conversion
- 0010 = MCCP1 Capture/Compare Event or Timer (CCP1IF/CCT1IF) ends sampling and starts conversion
- 0001 = INT0 event ends sampling and starts conversion
- 0000 = Clearing the Sample bit ends sampling and starts conversion

APPENDIX A: DOCUMENT REVISION HISTORY

Rev A Document (2/2013)

Initial release of this document; issued for Revision A0. Includes silicon issues 1-2 (A/D Converter) and 3-6 (MCCP and SCCP).

Rev B Document (9/2013)

Adds silicon issues 7 (MCCP and SCCP) and 8 (Op Amp) to Silicon Revision A0.

Adds data sheet clarification 1 (Memory Organization).

Rev C Document (3/2014)

Adds data sheet clarifications 2 (Electrical Characteristics), 3 (12-Bit A/D Converter with Threshold Detect) and 4 (Timer1).

Rev D Document (3/2015)

Adds silicon issue 9 (Reset) and data sheet clarifications 5 (Capture/Compare/PWM/Timer, MCCP and SCCP), 6 (Special Features), 7 (Master Synchronous Serial Port, MSSP), 8 (Real-Time Clock and Calendar, RTCC), 9 (Configurable Logic Cell), 10 (Electrical Characteristics) and 11-12 (Capture/Compare/PWM/Timer, MCCP and SCCP).

PIC24F16KM204 FAMILY

NOTES:

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights.

QUALITY MANAGEMENT SYSTEM CERTIFIED BY DNV = ISO/TS 16949=

Trademarks

The Microchip name and logo, the Microchip logo, dsPIC, FlashFlex, flexPWR, JukeBlox, KEELOQ, KEELOQ logo, Kleer, LANCheck, MediaLB, MOST, MOST logo, MPLAB, OptoLyzer, PIC, PICSTART, PIC³² logo, RightTouch, SpyNIC, SST, SST Logo, SuperFlash and UNI/O are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

The Embedded Control Solutions Company and mTouch are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Analog-for-the-Digital Age, BodyCom, chipKIT, chipKIT logo, CodeGuard, dsPICDEM, dsPICDEM.net, ECAN, In-Circuit Serial Programming, ICSP, Inter-Chip Connectivity, KleerNet, KleerNet logo, MiWi, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, MultiTRAK, NetDetach, Omniscient Code Generation, PICDEM, PICDEM.net, PICkit, PICtail, RightTouch logo, REAL ICE, SQI, Serial Quad I/O, Total Endurance, TSHARC, USBCheck, VariSense, ViewSpan, WiperLock, Wireless DNA, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

Silicon Storage Technology is a registered trademark of Microchip Technology Inc. in other countries.

GestIC is a registered trademarks of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2013-2015, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

ISBN: 978-1-63277-127-8

Microchip received ISO/TS-16949:2009 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and mulfacture of development systems is ISO 9001:2000 certified.



Worldwide Sales and Service

AMERICAS

Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277 Technical Support: http://www.microchip.com/ support

Web Address: www.microchip.com

Atlanta Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Austin, TX Tel: 512-257-3370

Boston Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL Tel: 630-285-0071 Fax: 630-285-0075

Cleveland Independence, OH Tel: 216-447-0464 Fax: 216-447-0643

Dallas Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit Novi, MI Tel: 248-848-4000

Houston, TX Tel: 281-894-5983

Indianapolis Noblesville, IN Tel: 317-773-8323 Fax: 317-773-5453

Los Angeles Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608

New York, NY Tel: 631-435-6000

San Jose, CA Tel: 408-735-9110

Canada - Toronto Tel: 905-673-0699 Fax: 905-673-6509

ASIA/PACIFIC

Asia Pacific Office Suites 3707-14, 37th Floor Tower 6, The Gateway Harbour City, Kowloon Hong Kong Tel: 852-2943-5100 Fax: 852-2401-3431 Australia - Sydney

Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

China - Beijing Tel: 86-10-8569-7000 Fax: 86-10-8528-2104

China - Chengdu Tel: 86-28-8665-5511 Fax: 86-28-8665-7889

China - Chongqing Tel: 86-23-8980-9588 Fax: 86-23-8980-9500

China - Dongguan Tel: 86-769-8702-9880

China - Hangzhou Tel: 86-571-8792-8115 Fax: 86-571-8792-8116

China - Hong Kong SAR Tel: 852-2943-5100 Fax: 852-2401-3431

China - Nanjing Tel: 86-25-8473-2460 Fax: 86-25-8473-2470

China - Qingdao Tel: 86-532-8502-7355 Fax: 86-532-8502-7205

China - Shanghai Tel: 86-21-5407-5533 Fax: 86-21-5407-5066

China - Shenyang Tel: 86-24-2334-2829 Fax: 86-24-2334-2393

China - Shenzhen Tel: 86-755-8864-2200 Fax: 86-755-8203-1760

China - Wuhan Tel: 86-27-5980-5300 Fax: 86-27-5980-5118

China - Xian Tel: 86-29-8833-7252 Fax: 86-29-8833-7256 ASIA/PACIFIC

China - Xiamen Tel: 86-592-2388138 Fax: 86-592-2388130

China - Zhuhai Tel: 86-756-3210040 Fax: 86-756-3210049

India - Bangalore Tel: 91-80-3090-4444 Fax: 91-80-3090-4123

India - New Delhi Tel: 91-11-4160-8631 Fax: 91-11-4160-8632

India - Pune Tel: 91-20-3019-1500

Japan - Osaka Tel: 81-6-6152-7160 Fax: 81-6-6152-9310

Japan - Tokyo Tel: 81-3-6880- 3770 Fax: 81-3-6880-3771

Korea - Daegu Tel: 82-53-744-4301 Fax: 82-53-744-4302

Korea - Seoul Tel: 82-2-554-7200 Fax: 82-2-558-5932 or 82-2-558-5934

Malaysia - Kuala Lumpur Tel: 60-3-6201-9857 Fax: 60-3-6201-9859

Malaysia - Penang Tel: 60-4-227-8870 Fax: 60-4-227-4068

Philippines - Manila Tel: 63-2-634-9065 Fax: 63-2-634-9069

Singapore Tel: 65-6334-8870 Fax: 65-6334-8850

Taiwan - Hsin Chu Tel: 886-3-5778-366 Fax: 886-3-5770-955

Taiwan - Kaohsiung Tel: 886-7-213-7828

Taiwan - Taipei Tel: 886-2-2508-8600 Fax: 886-2-2508-0102

Thailand - Bangkok Tel: 66-2-694-1351 Fax: 66-2-694-1350

EUROPE

Austria - Wels Tel: 43-7242-2244-39 Fax: 43-7242-2244-393 Denmark - Copenhagen Tel: 45-4450-2828 Fax: 45-4485-2829

France - Paris Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany - Dusseldorf Tel: 49-2129-3766400

Germany - Munich Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Germany - Pforzheim Tel: 49-7231-424750

Italy - Milan Tel: 39-0331-742611 Fax: 39-0331-466781

Italy - Venice Tel: 39-049-7625286

Netherlands - Drunen Tel: 31-416-690399 Fax: 31-416-690340

Poland - Warsaw Tel: 48-22-3325737

Spain - Madrid Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

Sweden - Stockholm Tel: 46-8-5090-4654

UK - Wokingham Tel: 44-118-921-5800 Fax: 44-118-921-5820